

DIVERSITY IN HOSPITALITY SCHOLARSHIP

The mission of the Hospitality Diversity Action Council (HDAC) is to be a catalyst for addressing the issues of systemic and institutionalized racism which has contributed to the lack of diversity within the hospitality industry. Through demonstrated leadership, as well as collaboration with the community, HDAC will work toward the creation of a more diverse, inclusive, and equitable industry through the implementation of programs, scholarships, and initiatives that promote and support Black, Indigenous People of Color (BIPOC) within all facets of the hospitality ecosystem.

The Diversity in Hospitality scholarship, a partnership between HDAC and NEWH, and underwritten by Emerald, works to encourage diversity, equity, and inclusion in and access to the hospitality industry by supporting students who identify with under-represented and minority groups interested in careers in the industry. Applicant must have submitted all required application materials to be eligible.

Eligibility

- Open to domestic and international students.
- Actively enrolled student; 2-year program freshman and above, 4-year program • sophomore/second year and above, or graduate level attending college
- 3.0 GPA (Cumulative) overall "B" average or grade percentage of 83% 86% equivalent
- Financial need through college for past/current/upcoming tuition or program approved books/supplies
- Major and career objective within a hospitality related field (interior design, hospitality management, culinary, etc.)
- High priority will be given to those who identity with an under-represented group in the industry.
- Awardee will be honored at the NEWH Young Entrepreneurs Breakfast at HD Expo + Conference, sponsored by Hospitality Design magazine. Attendance is encouraged.
- Applications must be received by February 24, 2023. If mailing, application must be postmarked four (4) days prior to deadline. Applications can be mailed to: NEWH, Inc., P.O. Box 322, Shawano, WI 54166.

Application Requirements

- **Official Transcript**: We understand sometimes transcripts and letter(s) may need to be sent in separately per college policy.
- Up to 2 letters of recommendation: (example from professor, advisor, employer, etc.)
- Student essay (500-word maximum) to include: What will your impact be?
 - Your goals and objectives
 - What prompted you to choose this career?
 - Why is obtaining this scholarship important to you?



Short Biography (150 words max)



High – Resolution Headshot







Submission:

Please collect all required materials (essay, transcript, letters) and combine into (1) PDF document and mail or email your submission. Include first and last name on all items submitted as header. We understand sometimes transcripts and letter(s) may need to be sent in separately per college policy.

Notification:

- All applications will receive an email notifying them of their application was received within 2 weeks of the scholarship deadline date. Winning students will receive notification no later than March 15, 2022. Other students will receive an email stating their application was not accepted no later than April 1, 2022.
- Awardee will be honored at HD Expo + Conference, sponsored by Hospitality Design magazine, attendance is encouraged. Travel and lodging are covered by HD Expo.
- Awarded funds are made payable to students' college or university and mailed directly to the institution. NEWH is unable to make funds payable directly to a student. Awarded funds may only be applied toward tuition or program-approved books/supplies for past, current or upcoming expenses or debt; unused funds are returned to NEWH.
- Awarded funds may not be used for students' other expenses (housing, personal needs, etc.)
- Students may apply for multiple NEWH scholarships, even if previously awarded.
- Scholarship Funds must be paid out by NEWH within 12 months after awarding. Any remaining funds will be returned to NEWH and no longer available to the scholarship recipient.

I have fully completed this application, supplied all necessary information accurately, included required attachments and submitted p rior to the deadline date or my application will not be considered. I hereby verify that all information included in this application is tr ue and accurate and understand that if NEWH, Inc. learns that any information is false, this application will not be considered. I fawar ded a scholarship, I understand that funds will be made payable to and directly mailed to my college and applied towards my tuition or program approved books/supplies. I understand unused funds will be returned to NEWH, Inc.

WAIVER OF LIABILITY AND HOLD HARMLESS AGREEMENT. If I receive a NEWH Scholarship award, including the opportunity to attend a scholarship awards event ("the Event"), I hereby release, waive, discharge and covenant not to sue HD, HDAC, Emerald, NEWH, Inc., its Chapters, affiliates, officers, directors, agents and employees (hereinafter referred to as "releasees") from any and all liability, claims, demands, actions and causes of action whatsoever arising out of or relating to any loss, damage or injury, including death, that may be sustained by me, or to any property belonging to me, whether caused by the negligence of the releasees, or otherwise, while participating in the Event, or while in, on or upon the premises where the Event is being conducted, while in transit to or from the premises, or in any place or places connected with the Event.

Connect/Questions: (p): 1.800.593.6394 Email: <u>newh.scholarship@newh.org</u> Facebook: @newhinc @NEWHScholarships Twitter: @NEWHinc Instagram: @newhinc

NEWH has awarded more than 7.4 million in scholarships and is the premier networking resource for the hospitality industry, providing scholarships, education, leadership development, recognition of excellence, and business development opportunities. Access jobs, internships, mentoring opportunities, events with hospitality professionals, increase your visibility and connect with industry leaders.





APPLICANT DETAILS

Name:			
	First	Middle	Last
Current Address:			
	City	State	Postal Code
Ethnicity: American Indian Alaskan Native Latino/Hispanic White/Caucasian	 Asian Pacific Is Middle E Mixed Ra 	lander East	k/African Indian r:
Birthdate:			
School Email:		Personal Email:	
Cell:		Other Phone:	
Student ID#:		Major:	
GPA/Overall Current Grade %::	☐ Wei	ghted Antici Gradu	pated lation Date
Degree: Associate	🗌 Bachelor 🗌 Gradua	ate Other:	
College Name:			
Address of College:			
_	City	State	Postal Code
Semester(s) to apply scho	plarship funds towards (fall/s	spring)	
Permanent Address: (not your address at school)			
-	City	State	Postal Code
	-		
Total Units/Credits/Hours	s <u>Required for Degree</u> :		
Total Units/Credits/Hours	s <u>Completed to Date</u> :		
Units/Credits/Hours Curr	ently Enrolled In:		





List of Current Classes:			Units/Hrs./Credits
Professional Organizatio	ons or Extracurricular activities yo	ou are involved in	
Professional Special Certi	ifications:		
Have you Participated in a Student Intern Program?			□ NO
lf yes, please list company	/:		
Work Experience:			
	Job Title	Datas	
Company		Dates	Hours per week
Company		Dates	Hours per week
Company			Hours per week
Company			Hours per week
			Hours per week
Company Are you a former NEWH Scholarship Name:			Hours per week





APPLICANT FINANCIAL INFORMATION:

Estimated income and expenses from now until next year; meaning a 12-month period

INCOME		EXPENSES		
	Estimated Amount		Estimated Amoun	
Estimated earnings from your job while in school:	\$	Tuition/Fees – Semester 1:	\$	
Income from Work-Study program (applied to tuition):	\$	Tuition/Fees – Semester 2:	\$	
INCOME		EXPENSES		
Personal Funds (Cash, Savings, etc.):	\$	Tuition/Fees – Summer:	\$	
		Total Yearly Tuition/Fees	\$	
Total Grants Awarded:	\$			
Total Scholarships Awarded:		Program Approved Books/Supplies:	\$	
Parental Loans for Tuition:	\$	Loans/Debt (Bank/Gov.):	\$	
Parental Support for	\$	Housing Costs (Rent, Room &	\$	
Expenses:		Board, Including Bills):		
Do you have to pay back your parental support/loans?	Yes/No			
		Transportation (Care/Fares):	\$	
Spousal Income:	\$	Medical/Insurance:	\$	
		Child Care Expenses:	\$	
Other Income:	\$			
	\$	Other Expenses:	\$	
	\$		\$	
	\$		\$	
TOTAL INCOME:	\$	TOTAL EXPENSES:	\$	
Anticipated Incoming	\$	Future Estimated Educational	\$	
Scholarships/Grants		Debt:		
	\$	Date Range:	From: To:	
	\$	Current Educational Debt:	\$	
	\$			
vrovide any details you need t	o further explain (or)	include a separate sheet with you	ur submission):	

I have fully completed this application, supplied all necessary information accurately, included required attachments and submitted prior to the deadline date or my application will not be considered. I hereby verify that all information included in this application is true and accurate and understand that if NEWH, Inc. learns that any information is false, this application will not be considered. I hereby verify that all information included in this application is true and accurate and understand that if NEWH, Inc. learns that any information is false, this application will not be considered. If awarded a scholarship, I understand that funds will be made payable to and directly mailed to my college and applied towards my tuition or program approved books/supplies. I understand unused funds will be returned to NEWH, Inc.

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Signature:







2022

